



40V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
N Channal	40V	$45\text{m}\Omega$ @ $V_{GS} = 10V$	4.5A
N-Channel	407	$58m\Omega$ @ $V_{GS} = 4.5V$	T _A = +25°C
D Channal	-40V	$65m\Omega$ @ $V_{GS} = -10V$	-3.7A
P-Channel	- 4 0V	100mΩ @ V _{GS} = -4.5V	-2.9A

Description and Applications

This new generation complementary MOSFET H-Bridge features 2 N and 2 P channels in an SO-8 package. Qualified to AEC-Q101 the H bridge is ideally suited to driving:

- Solenoids
- DC Motors
- Audio Outputs

Features

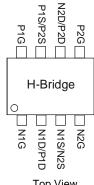
- 2 x N + 2 x P Channels in An SO-8 Package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

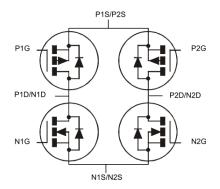
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (Approximate)







Top View Pin Configuration



Internal Schematic

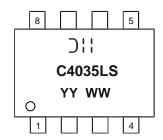
Ordering Information (Note 5)

Ī	Part Number	Compliance	Case	Packaging
	DMHC4035LSDQ-13	Automotive	SO-8	2,500/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS). 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



OH = Manufacturer's Marking Cde C4035LS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 18 = 2018) WW = Week (01 to 53)



Thermal Characteristics ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 6)		P _D	1.5	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D.	85	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	53		
Thermal Resistance, Junction to Case	R _{θJC}	15			
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Maximum Ratings N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	40	V	
Gate-Source Voltage			V _{GSS}	±20	V
Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$		I _D	4.5 3.5	А	
Continuous Drain Current (Note 6) V _{GS} = 10V	$t < 10s$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I _D	5.8 4.5	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V Steady State t<10s		$T_A = +25$ °C $T_A = +70$ °C	I _D	4 3.1	А
		$T_A = +25$ °C $T_A = +70$ °C	I _D	5.1 4	А
Maximum Continuous Body Diode Forward Current	(Note 6)	Is	1.5	Α	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	I _{DM}	25	А		

Maximum Ratings P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-40	V	
Gate-Source Voltage		V _{GSS}	±20	V	
		I _D	-3.7 -2.9	А	
Continuous Drain Current (Note 6) V _{GS} = -10V	t<10s	T _A = +25°C T _A = +70°C	I _D	-4.8 -3.8	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-2.9 -2.3	А
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-3.9 -3.0	А
Maximum Continuous Body Diode Forward Curren	t (Note 6)	Is	-1.5	Α	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	%)	I _{DM}	-15	А	

Note: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

DMHC4035LSDQ Document number: DS37219 Rev. 2 - 2



Electrical Characteristics N-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 40V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance			26	45	mΩ	$V_{GS} = 10V, I_D = 3.9A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	35	58	11122	$V_{GS} = 4.5V, I_D = 3.5A$
Diode Forward Voltage	V_{SD}	_	0.7	1	V	V _{GS} = 0V, I _S = 1.25A
DYNAMIC CHARACTERISTICS (Note 8)				•		
Input Capacitance	C _{iss}	_	574	_		$V_{DS} = 20V$, $V_{GS} = 0V$, $f = 1MHz$
Output Capacitance	Coss		87.8	_	pF	
Reverse Transfer Capacitance	Crss	_	38.7	_		
Gate Resistance	Rg	_	1.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.9	_		
Total Gate Charge (V _{GS} = 10V)	Qg		12.5	_	nC	V 20V I 2.0A
Gate-Source Charge	Q_{gs}	_	1.7	_	nc	$V_{DS} = 20V, I_{D} = 3.9A$
Gate-Drain Charge	Q_{gd}		2.2	_		
Turn-On Delay Time	t _{D(ON)}		3.1	_		
Turn-On Rise Time	t _R		2.6	_	ns	$V_{DD} = 20V, V_{GS} = 10V,$
Turn-Off Delay Time	t _{D(OFF)}	1	15	_	115	$R_L = 20\Omega$, $R_G = 6\Omega$
Turn-Off Fall Time	t _F	_	5.5	_		
Reverse Recovery Time	t _{RR}	_	6.5	_	ns	I _F = 3.9A, di/dt = 500A/µs
Reverse Recovery Charge	Q_{RR}	_	1.2	_	nC	1 0.0Λ, αναι – 000Λ μο

$\textbf{Electrical Characteristics P-CHANNEL} \ (@T_A = +25^{\circ}C, \ unless \ otherwise \ specified.)$

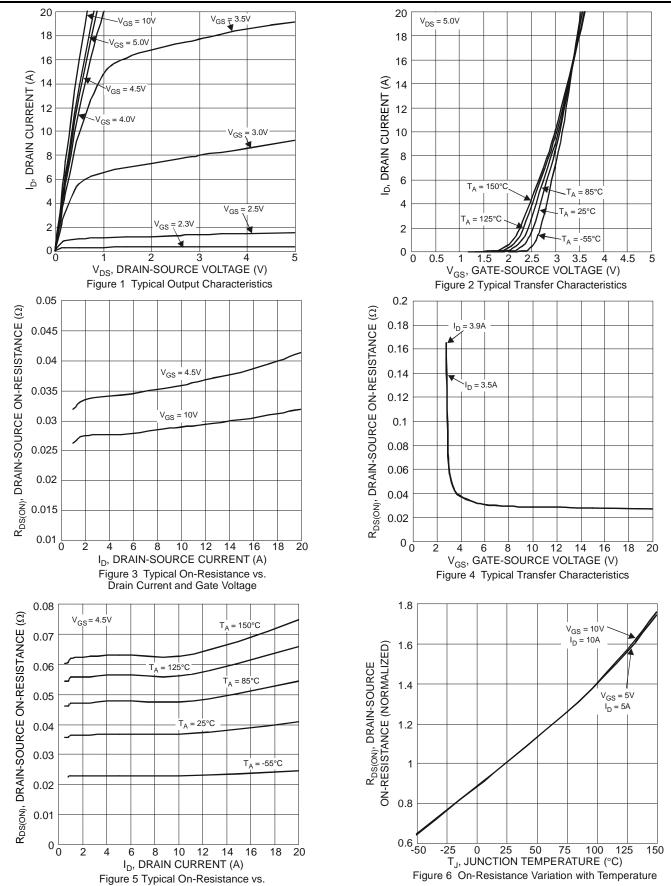
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μA	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)					•	•	
Gate Threshold Voltage	V _{GS(TH)}	-1	_	-3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	_	_	49	65	mΩ	$V_{GS} = -10V, I_D = -4.2A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	73	100	11177	V _{GS} = -4.5V, I _D = -3.3A	
Diode Forward Voltage	V_{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)					•	•	
Input Capacitance	C _{iss}	_	587	_	pF		
Output Capacitance	Coss	_	88.1	_	pF	$V_{DS} = -20V, V_{GS} = 0V,$ f = 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	40.2	_	pF	-I = IIVIHZ	
Gate Resistance	Rg	_	12.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	5.4	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	11.1	_	nC	1, , , , , , , , , , , , , , , , , , ,	
Gate-Source Charge	Q _{gs}	_	1.5	_	nC	$V_{DS} = -20V, I_{D} = -4.2A$	
Gate-Drain Charge	Q _{gd}	_	2	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	3.6	_	ns		
Turn-On Rise Time	t _R	_	2.9	_	ns	$V_{DD} = -15V$, $V_{GS} = -10V$,	
Turn-Off Delay Time	t _{D(OFF)}	_	36.3	_	ns	$R_G = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _F	_	15.3	_	ns		
Reverse Recovery Time	t _{RR}	_	15.5	_	ns	I _F = -4.2A, di/dt = 500A/µs	
Reverse Recovery Charge	Q _{RR}	_	16.9	_	nC	7 IF = -4.2A, αι/αι = 500A/μS	

Notes: 7. Short duration pulse test used to minimize self-heating effect.

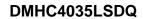
8. Guaranteed by design. Not subject to product testing.



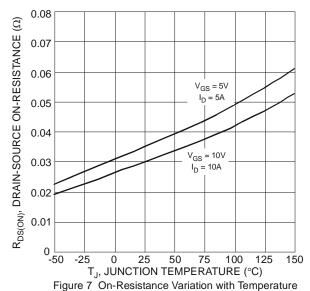
Typical Characteristics - N-CHANNEL

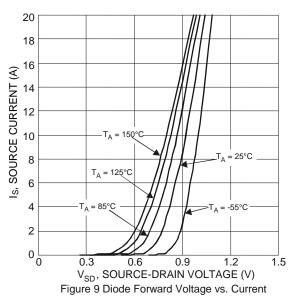


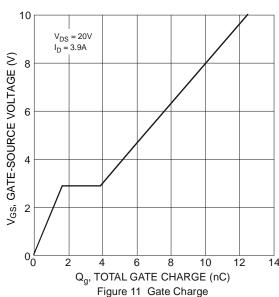
Drain Current and Temperature











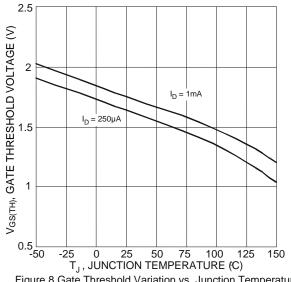
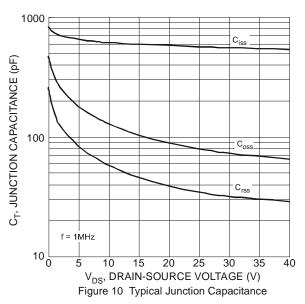
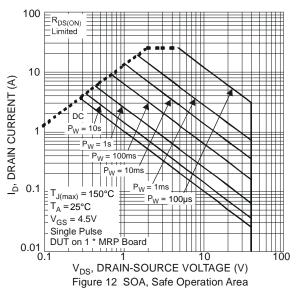


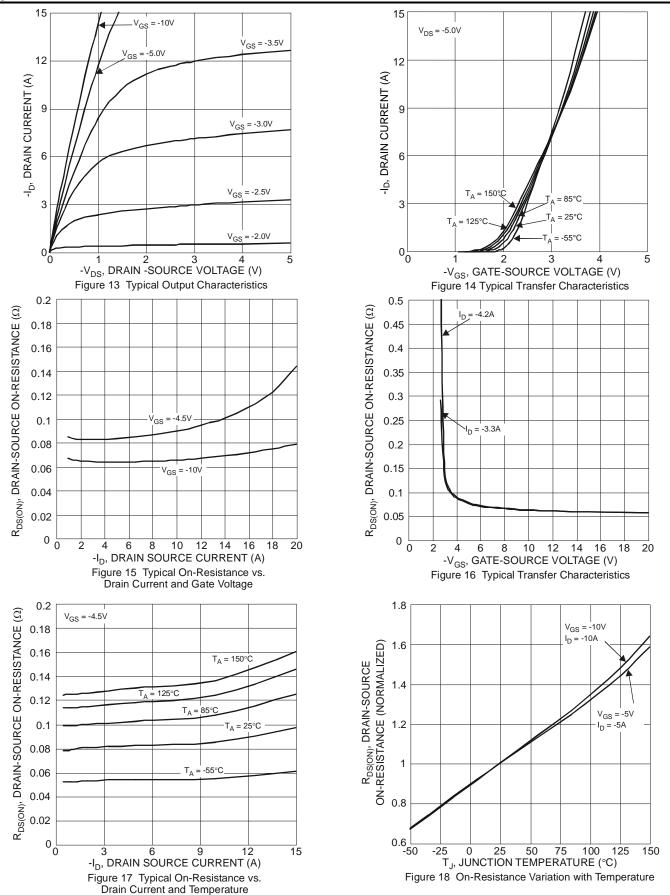
Figure 8 Gate Threshold Variation vs. Junction Temperature



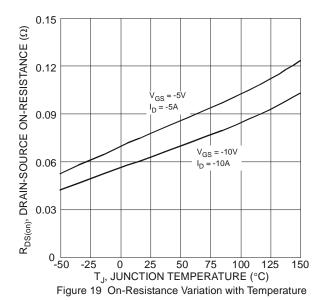


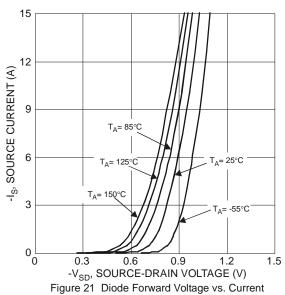


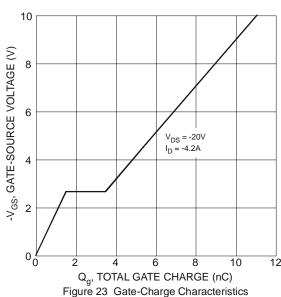
Typical Characteristics - P-CHANNEL











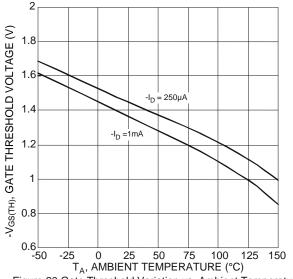
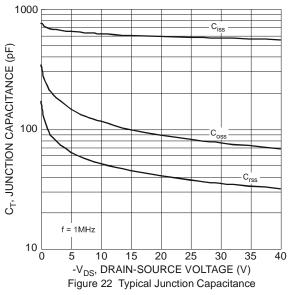
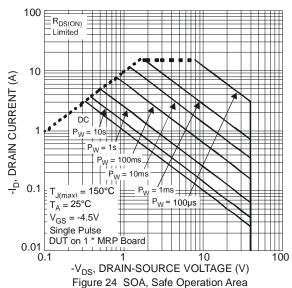
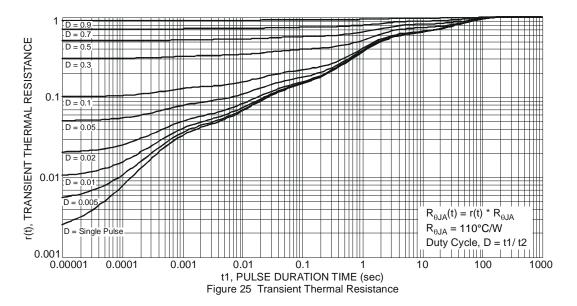


Figure 20 Gate Threshold Variation vs. Ambient Temperature



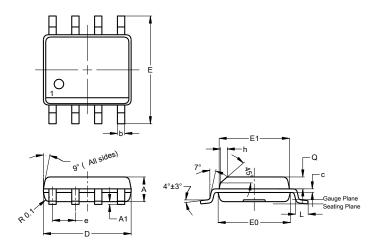






Package Outline Dimensions

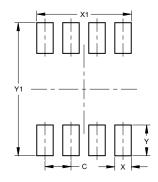
Please see http://www.diodes.com/package-outlines.html for the latest version.



SO-8						
Dim	Min	Max	Тур			
Α	1.40	1.50	1.45			
A1	0.10	0.20	0.15			
b	0.30	0.50	0.40			
С	0.15	0.25	0.20			
D	4.85	4.95	4.90			
Е	5.90	6.10	6.00			
E1	3.80	3.90	3.85			
E0	3.85	3.95	3.90			
е	-		1.27			
h	-		0.35			
L	0.62	0.82	0.72			
q	0.60	0.70	0.65			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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